

US00D561711S

(12) **United States Design Patent** (10) **Patent No.:** **US D561,711 S**
Lin (45) **Date of Patent:** **** Feb. 12, 2008**

(54) **HEAT SINK**

(75) Inventor: **Pei-Hsi Lin**, Sijhih (TW)

(73) Assignee: **Thermaltake Technology Co., Ltd.**
(TW)

(**) Term: **14 Years**

(21) Appl. No.: **29/275,687**

(22) Filed: **Jan. 4, 2007**

(30) **Foreign Application Priority Data**

Dec. 8, 2006 (TW) 095306823

(51) **LOC (8) Cl.** **13-03**

(52) **U.S. Cl.** **D13/179**

(58) **Field of Classification Search** D13/179;
165/80.3, 104.33, 151, 122, 185; 257/706,
257/707, 718-722; 361/687, 695, 697, 700,
361/702, 704, 709, 710, 711, 719
See application file for complete search history.

(56) **References Cited**

U.S. PATENT DOCUMENTS

D480,692 S * 10/2003 Lee D13/179
6,883,592 B2 * 4/2005 Lee 165/80.3

D541,757 S * 5/2007 Lee D13/179
2002/0182068 A1 * 12/2002 Liu 415/176
2005/0067144 A1 * 3/2005 Chou 165/80.3
2006/0061970 A1 * 3/2006 Lee 361/709
2006/0082972 A1 * 4/2006 Kim 361/709
2006/0137861 A1 * 6/2006 Wang et al. 165/104.33

* cited by examiner

Primary Examiner—Selina Sikder

(74) *Attorney, Agent, or Firm*—Schmeiser, Olsen & Watts

(57) **CLAIM**

The ornamental design for a heat sink, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a heat sink;

FIG. 2 is a front elevation thereof;

FIG. 3 is a rear elevation thereof;

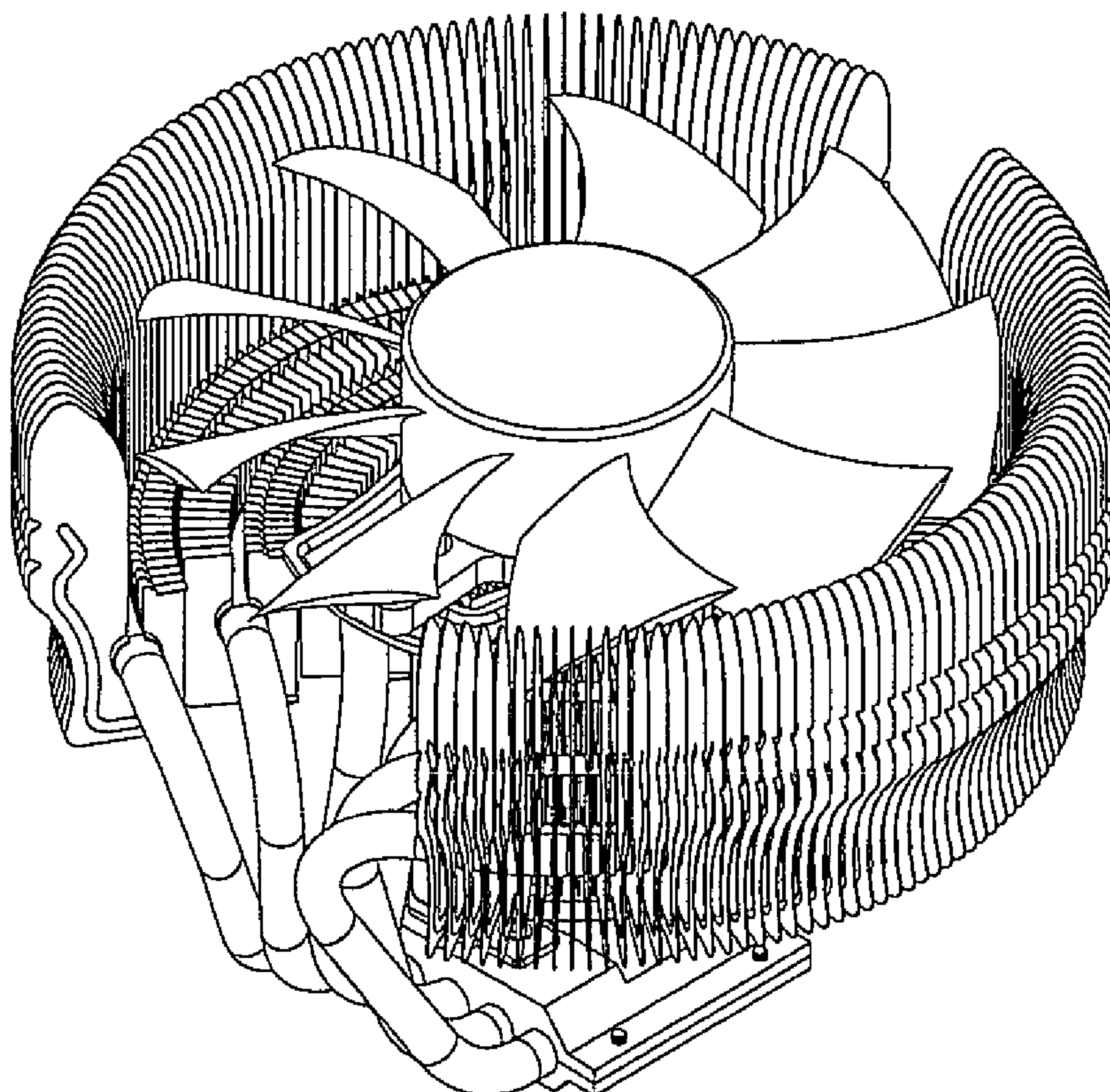
FIG. 4 is a left side elevation thereof;

FIG. 5 is a right side elevation thereof;

FIG. 6 is a top plan view thereof; and,

FIG. 7 is a bottom view thereof.

1 Claim, 4 Drawing Sheets



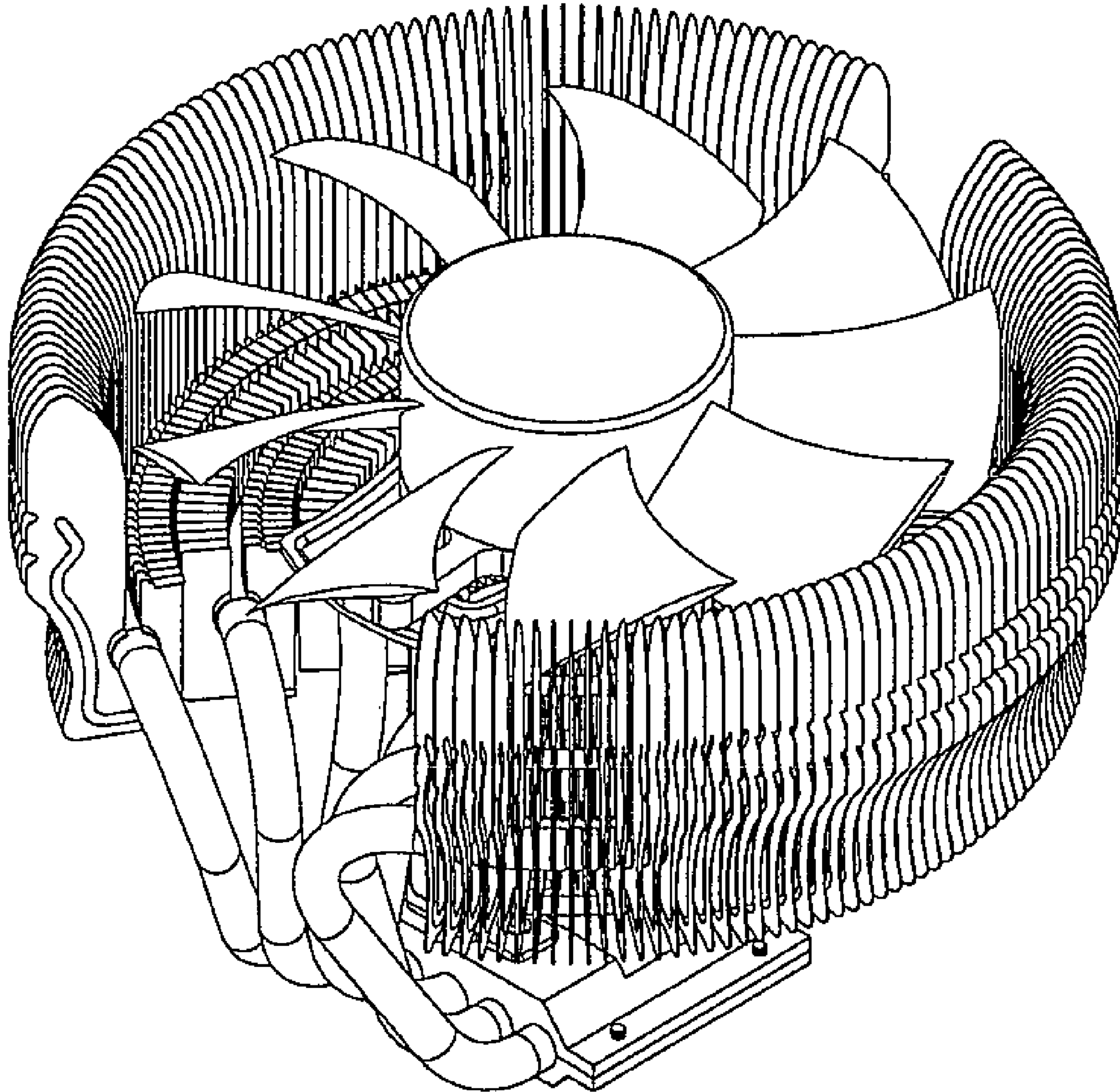


Fig. 1

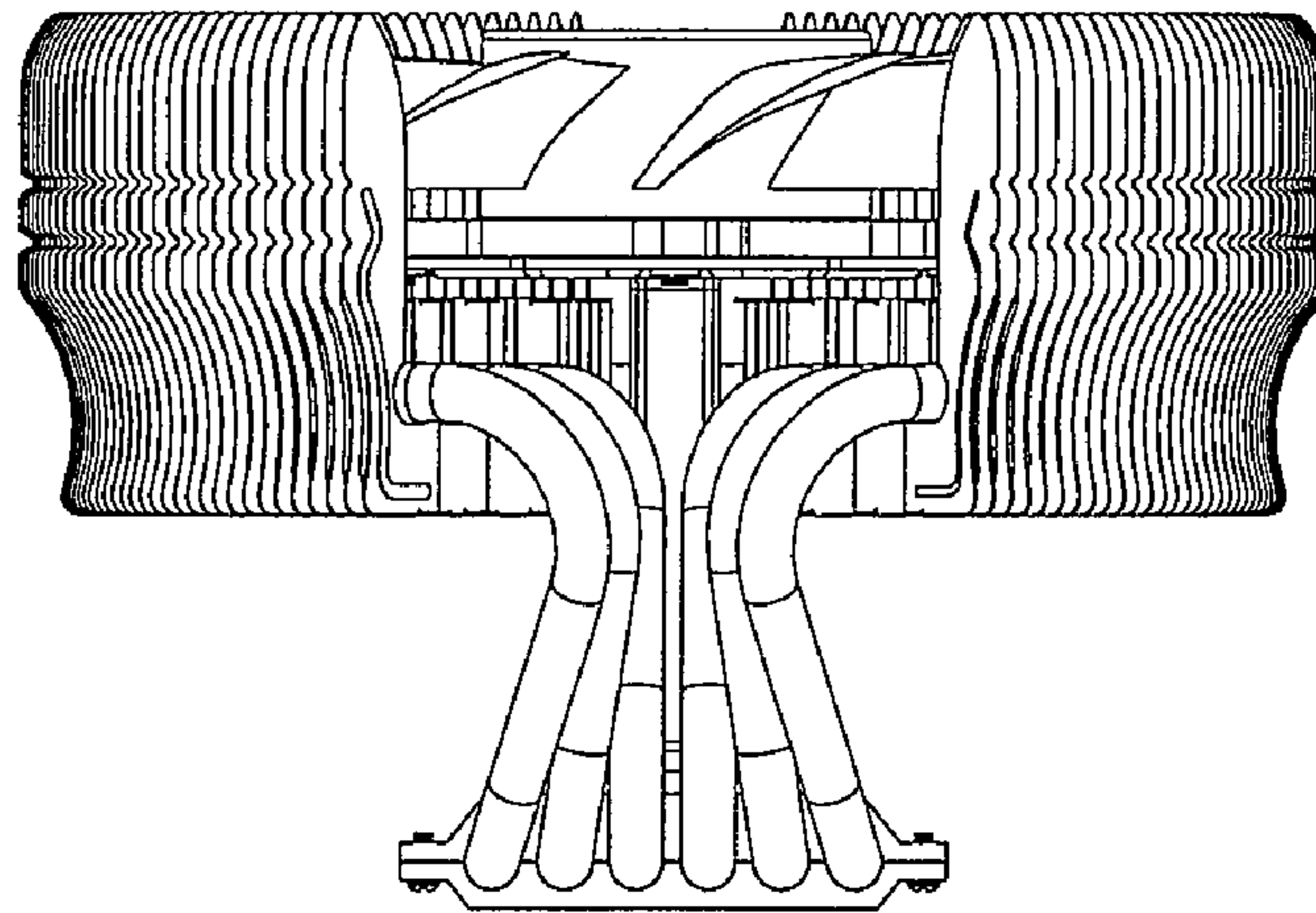


Fig. 2

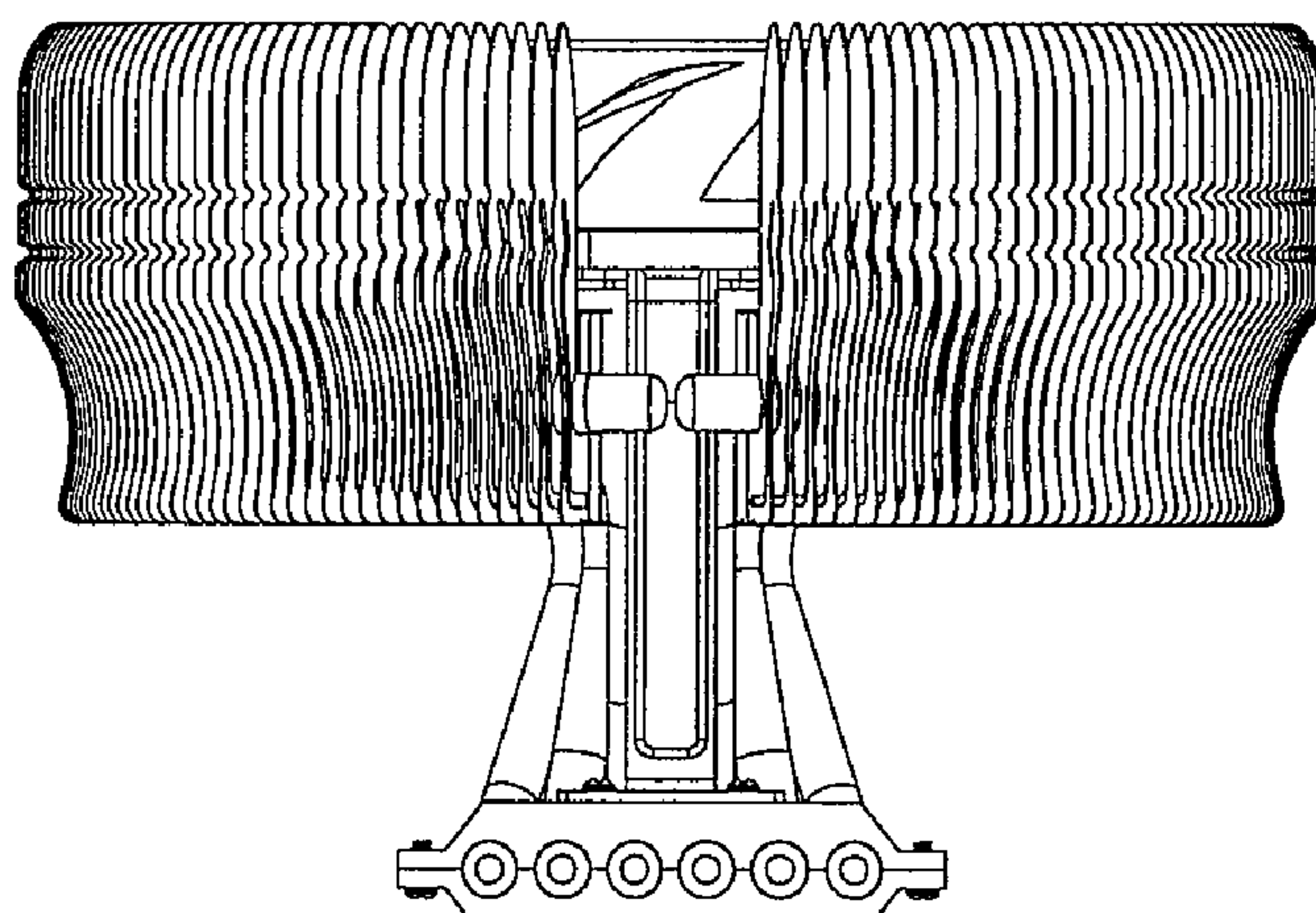


Fig. 3

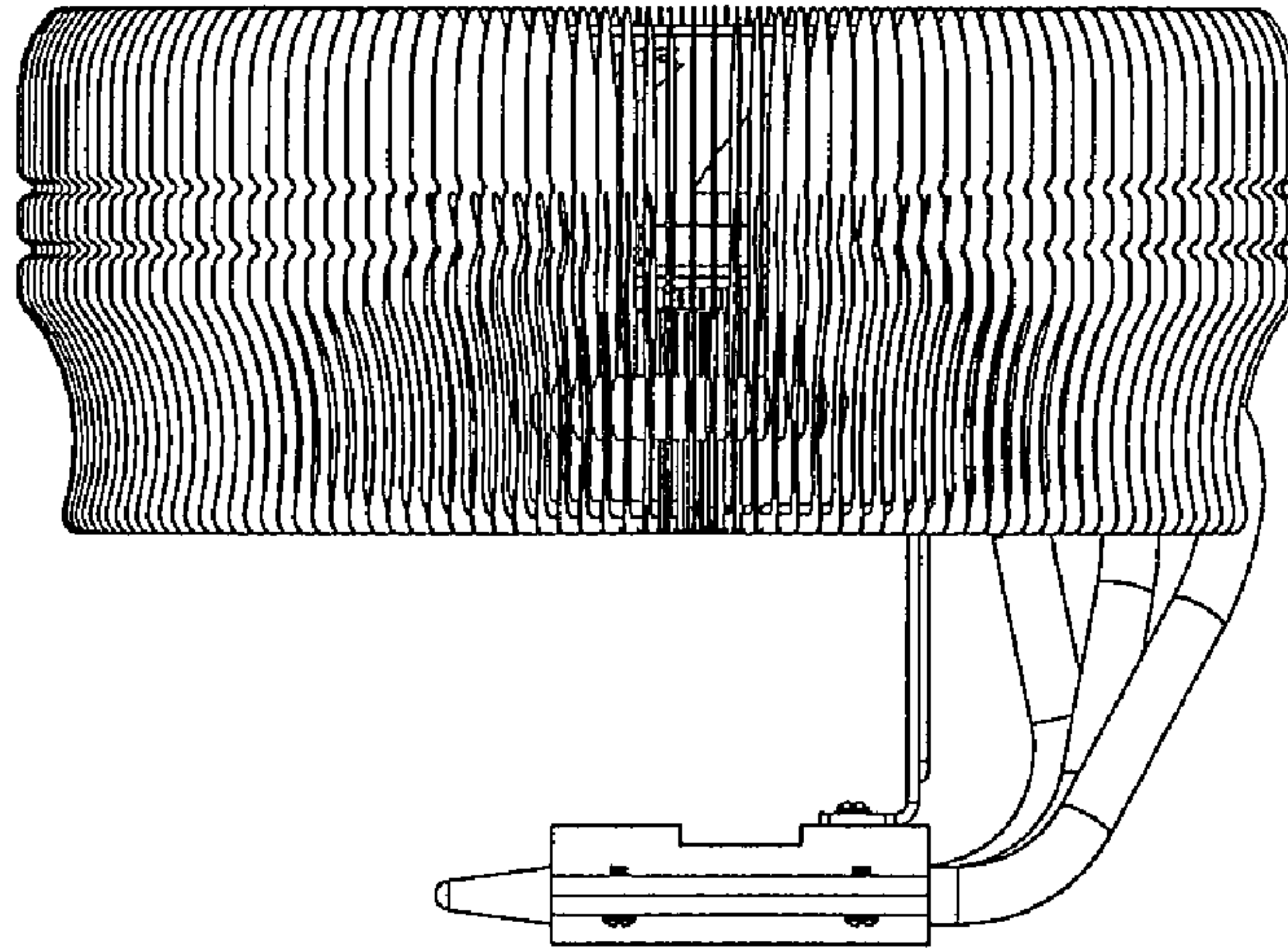


Fig. 4

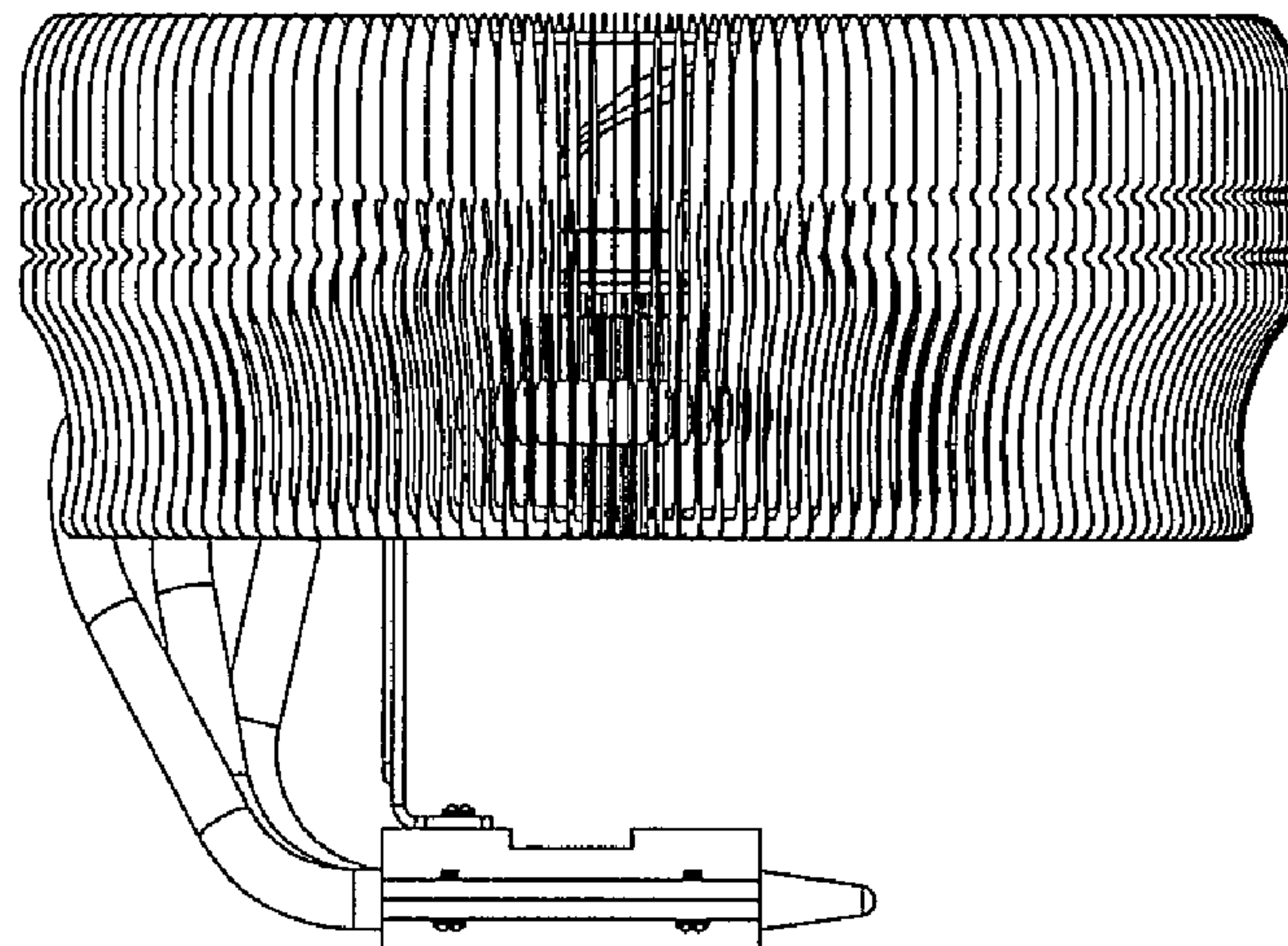


Fig. 5

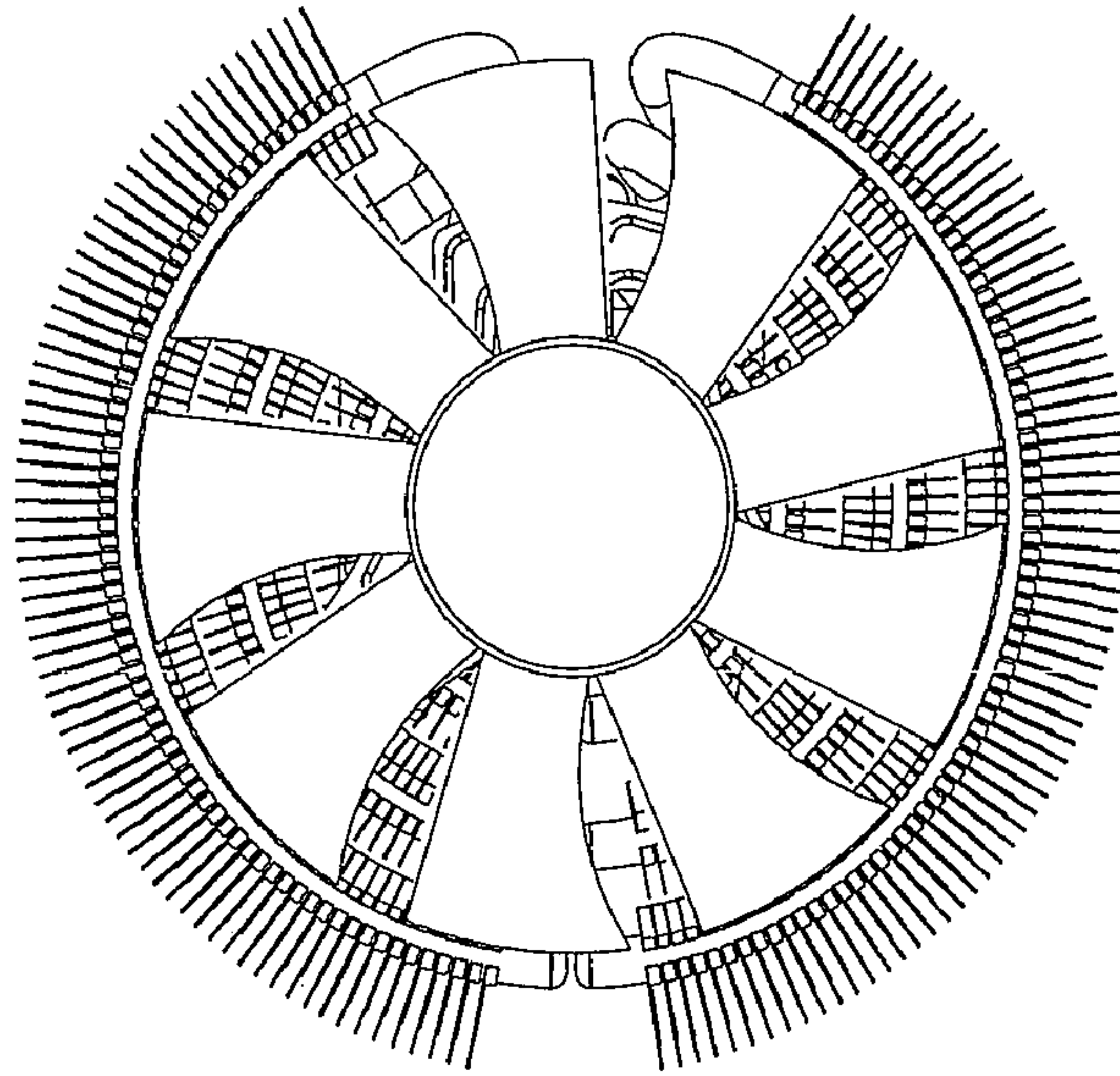


Fig. 6

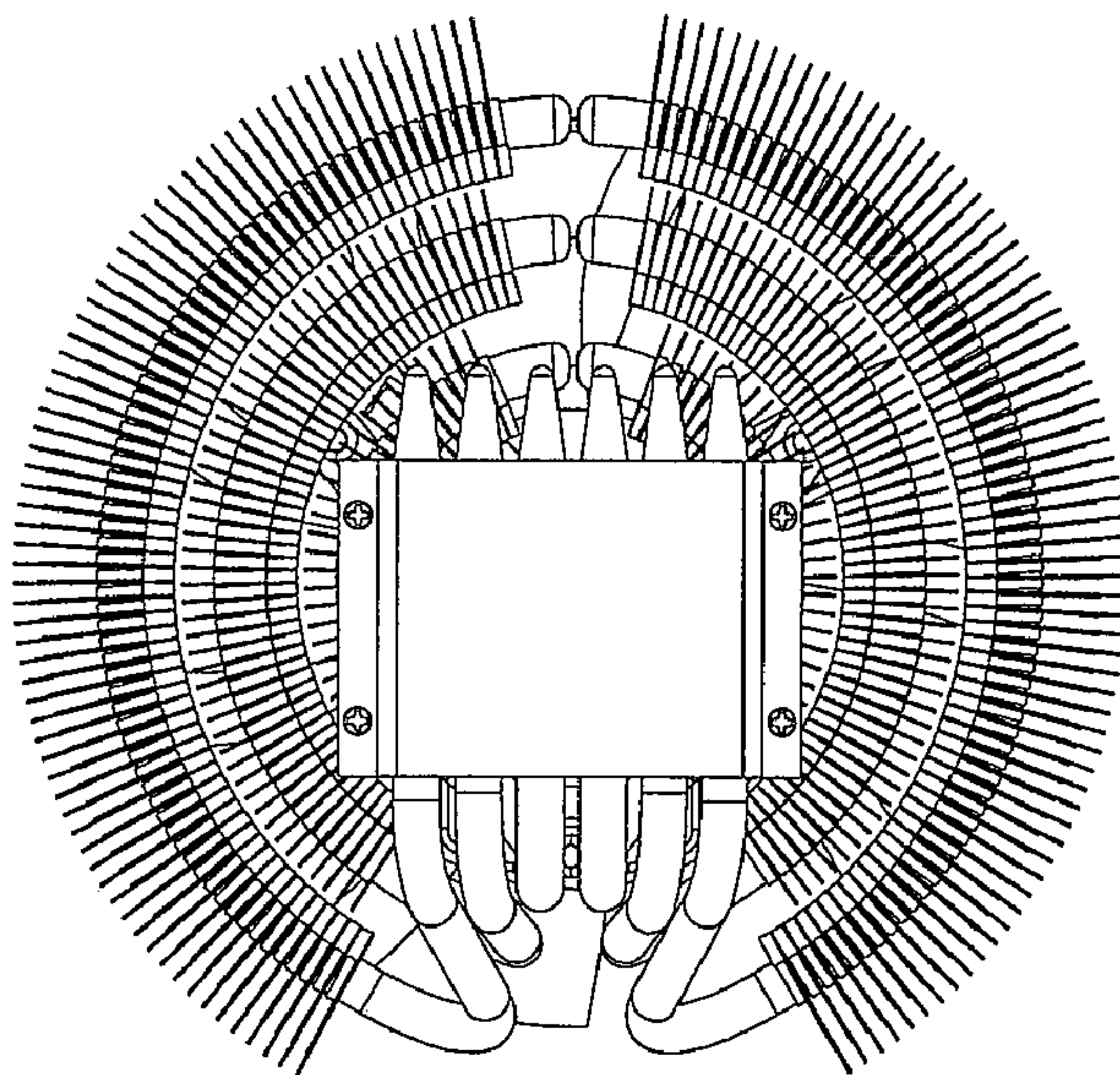


Fig. 7